

RECORDATION FORM COVER SHEET

Docket No.: 050212-0360

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

SIXON Ltd.

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): April 18, 2008

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

2. Name and address of receiving party(ies)

Name: SUMITOMO ELECTRIC INDUSTRIES, LTD.

Internal Address:

Address: 5-33, Kitahama 4-chome
Chuo-ku, Osaka-shi
Osaka, 541-0041 JAPAN

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

A. Patent Application No(s).

☐ This document is being filed together with a new application.

B. Patent No(s).

6,734,461

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

Phone Number: 202.756.8000

Fax Number: 202.756.8087

Email Address:

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☐ Authorized to be charged by credit card
☒ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information:

a. Credit Card Last 4 Numbers

Expiration Date

b. Deposit Account Number 500417

Authorized User Name

9. Signature.

Judith L. Toffenetti, Registration No. 39,048

Name and Registration No. of Person Signing

Signature

May 28, 2008

Date

Total number of pages including cover sheet, attachments and documents: 2

GH \$40.00 500417 6734461

Docket No.: 50212-360

ASSIGNMENT

WHEREAS SIXON Ltd. and SUMITOMO ELECTRIC INDUSTRIES, LTD., are the owners of the entire right, title and interest of the following:

U.S. Patent Number: 6,734,461

U.S. Serial Number: 10/070,472

Issue Date: May 11, 2004

Filing Date: March 7, 2002; PCT Filing Date September 6, 2000

For: SIC WAFER, SIC SEMICONDUCTOR DEVICE, AND PRODUCTION METHOD OF SIC WAFER

Inventors: Hiromu Shiomi; Tsunenobu Kimoto; and Hiroyuki Matsunami

by virtue of an Assignment executed on February 8, 2008

AND WHEREAS, SUMITOMO ELECTRIC INDUSTRIES, LTD., a Japanese Company having an address of 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 541-0041 Japan is desirous of acquiring from SIXON Ltd. its interest in the entire right, title and interest in and to said United States Patent 6,734,461, its legal representatives, successors, and assigns, thereby owning the entire right, title and interest in and to United States Patent 6,734,461;

NOW THEREFORE, for good and valuable consideration, the receipt for and sufficiency of which is hereby acknowledged, the said SIXON Ltd., do hereby sell, assign, transfer and set over unto SUMITOMO ELECTRIC INDUSTRIES, LTD., its legal representatives, successors, and assigns, its interest in the entire right, title and interest in and to United States Patent 6,734,461;

UPON SAID CONSIDERATIONS, the undersigned hereby agree to transfer said interest of the entire right title and interest of the above Patent, and to render all necessary assistance in executing any papers by the said SUMITOMO ELECTRIC INDUSTRIES, LTD., their successors, assigns and legal representatives, deemed essential to SUMITOMO ELECTRIC INDUSTRIES, LTD. full protection and title in and to the invention;

AND We hereby grant the Assignee, its successors, legal representatives and assigns, the power to insert on this instrument any further identification that may be necessary or desirable to comply with the recordation rules of any appropriate and competent authority, including, without limitation, the United States Patent and Trademark Office.

SIXON Ltd.

Michikazu Murakami

Officer: Michikazu MURAKAMI

Title:

Date: Representative Liquidator

April 18, 2008